06/12/2017 504407670

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT4454368

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
WEN-CHE TSAI	06/02/2017
MIN-YANN HSIEH	06/02/2017
HUA-FENG CHEN	06/02/2017
KUO-HUA PAN	06/02/2017

RECEIVING PARTY DATA

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City:	HSINCHU		
State/Country:	TAIWAN		
Postal Code:	300		

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	15619595	

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SIGNATURE:	/Daniel R. McClure/
DATE SIGNED:	06/12/2017

Total Attachments: 2

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> **PATENT** REEL: 042671 FRAME: 0919 504407670

NP-20301-US/P20162102US00

Inventor(s)-to-Assignee

ASSIGNMENT

This assignment agreement is applicable to an invention entitled (Invention Title)				
METHOD FOR MANUFACTURING A SEMICONDUCTOR DEVICE				
The PATENT RIGHTS referred to in this agreement are:				
(check one) ⊠a patent application for this invention, executed by the ASSIGNOR(S)				
concurrently with this assignment.				
U.S. patent application Serial No,filed				
a U.S. patent application based on PCT International Application				
Nofiled on (date)(U.S. patent application				
Serial No, if known).				
U.S. patent No, issued				
The PATENT RIGHTS also include all divisions, reissues, continuations and extensions of				
the patents and patent applications identified above.				
The PATENT RIGHTS assigned under this agreement are:				
(check one) ⊠U.S. patent rights only.				
Worldwide patent rights. In this case, the assignee shall have the right to				
claim the benefit of the filing date of any U.S. or foreign patent application				
for this invention.				
The ASSIGNOR(S) referred to in this agreement is (or are) the inventor(s) whose signatures				
appear on page 2 of this Assignment and any Supplemental Sheet(s).				
The ASSIGNEE referred to in this agreement is:				
(Name of Assignee) TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.				
(Address) NO.8, LI-HSIN RD.6, SCIENCE-BASED INDUSTRIAL PARK, HSINCHU,				
TAIWAN 300, R.O.C.				
The ASSIGNEE is:				
(check one) An individual.				
A Partnership.				
☐A Corporation of				
(other)				
The ASSIGNOR(S), in consideration of \$10.00 paid by the ASSIGNEE, and other good and				
valuable consideration, receipt of which is acknowledged, hereby assign(s) the following				
rights to the ASSIGNEE, its successors and assigns:				
the full and exclusive right to the invention;				
the entire right, title and interest in and to the PATENT RIGHTS;				
the right to sue and recover for any past infringement; and				
the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable				

provisions, based on any earlier patent applications for this invention.

PATENT REEL: 042671 FRAME: 0920 NP-20301-US/P20162102US00

RECORDED: 06/12/2017

THIS IS PAGE 2 OF AN ASSIGNMENT FROM THE INVENTOR(S) TO
ASSIGNEE: TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.
INVENTION TITLE: METHOD FOR MANUFACTURING A SEMICONDUCTOR
DEVICE

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Commissioner of Patents and Trademark to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any fact known to the ASSIGNOR(S) with respect to said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause and all Letter Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNOR(S) authorize(s) the attorneys and agents who have the power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.

Wen-Che TSAI	TsoT Wen Che	>0/7.06.02
Name of sole or first inventor	Signature	Date /
Min-Yann HSIEH	Min-Tann HSIEH	2017.06.02
Name of second inventor, if any	Signature	Date
Hua-Feng CHEN	Hug-Fery Chen	2017.06.02
Name of third inventor, if any	Signature	Date
Kuo-Hua PAN	Kuo-Hua, Pan	y017.06.02
Name of fourth inventor, if any	Signature	Date

PATENT REEL: 042671 FRAME: 0921